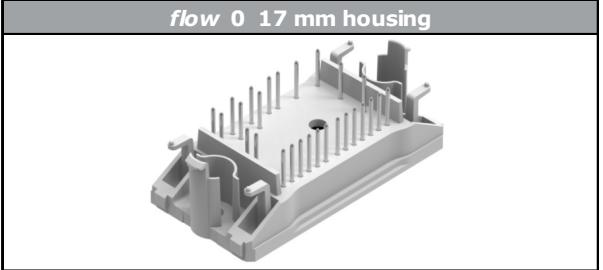
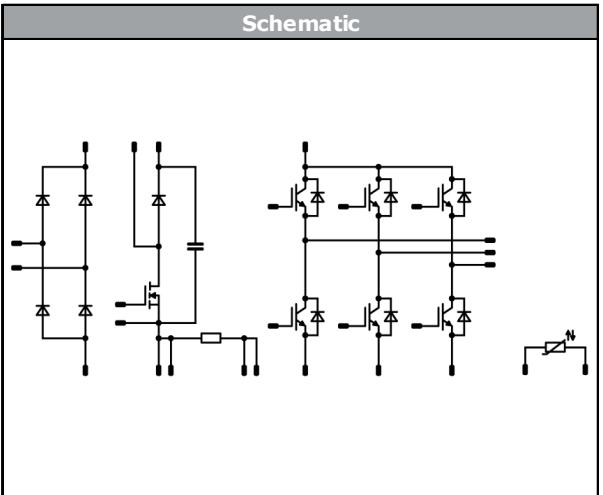




Vincotech

flow PIM 0 + PFC		600 V / 15 A
Features		
• Clip in PCB mounting • Trench Fieldstop IGBT's for low saturation losses • Latest generation superjunction MOSFET for PFC		
Target applications		
• Industrial Drives • Embedded Drives	Schematic	
Types		
• 10-F006PPA015SB-M684B		

Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Rectifier Diode				
Peak Repetitive Reverse Voltage	V_{RRM}		1600	V
Continuous (direct) forward current	I_F		25	A
Surge (non-repetitive) forward current	I_{FSM}	50 Hz Single Half Sine Wave $t_p = 10 \text{ ms}$	200	A
Surge current capability	I_{P_t}		200	A^2s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$	44	W
Maximum Junction Temperature	T_{jmax}		150	$^\circ\text{C}$



Vincotech

Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
PFC Switch				
Drain-source voltage	V_{DS}		600	V
Drain current	I_D		20	A
Peak drain current	$I_{D\text{pulse}}$	t_p limited by $T_{j\text{max}}$	159	A
Avalanche energy, single pulse	E_{AS}	$I_D = 9,3 \text{ A}$ $V_{DD} = 50 \text{ V}$	1135	mJ
Avalanche energy, repetitive	E_{AR}	$I_D = 9,3 \text{ A}$ $V_{DD} = 50 \text{ V}$	1,7	mJ
Avalanche current, repetitive	I_{AR}	t_p limited by $T_{j\text{max}}$ $P_{AV} = E_{AR} \cdot f$	9,3	A
MOSFET dv/dt ruggedness	dv/dt	$V_{DS} = 0-480 \text{ V}$	50	V/ns
Total power dissipation	P_{tot}	$T_j = T_{j\text{max}}$ $T_s = 80^\circ\text{C}$	64	W
Gate-source voltage	V_{GS}		± 20	V
Reverse diode dv/dt	dv/dt	$V_{DS} = 0-480 \text{ V}$	15	V/ns
Maximum Junction Temperature	$T_{j\text{max}}$		150	$^\circ\text{C}$
PFC Diode				
Peak Repetitive Reverse Voltage	V_{RRM}		600	V
Continuous (direct) forward current	I_F		30	A
Surge (non-repetitive) forward current	I_{FSM}	60 Hz Single Half Sine Wave $t_p = 8,3 \text{ ms}$	300	A
Total power dissipation	P_{tot}	$T_j = T_{j\text{max}}$ $T_s = 80^\circ\text{C}$	52	W
Maximum Junction Temperature	$T_{j\text{max}}$		175	$^\circ\text{C}$
Capacitor (PFC)				
Maximum DC voltage	V_{MAX}		500	V
Operation Temperature	T_{op}		-55...+125	$^\circ\text{C}$
PFC Shunt				
DC forward current	I_F	terminal temperature $T_k \leq 90^\circ\text{C}$	22	A
Power dissipation	P_{tot}	terminal temperature $T_k \leq 90^\circ\text{C}$	5	W



Vincotech

Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Inverter Switch				
Collector-emitter voltage	V_{CES}		600	V
Collector current	I_C		15	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	45	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	52	W
Gate-emitter voltage	V_{GES}		± 20	V
Short circuit ratings	t_{SC} V_{CC}	$T_j \leq 150^\circ\text{C}$ $V_{GE} = 15\text{ V}$	6 360	μs V
Maximum Junction Temperature	T_{jmax}		175	$^\circ\text{C}$

Inverter Diode

Peak Repetitive Reverse Voltage	V_{RRM}		600	V
Continuous (direct) forward current	I_F		15	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	30	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	35	W
Maximum Junction Temperature	T_{jmax}		175	$^\circ\text{C}$

Module Properties

Thermal Properties				
Storage temperature	T_{stg}		-40...+125	$^\circ\text{C}$
Operation temperature under switching condition	T_{jop}		-40...($T_{jmax} - 25$)	$^\circ\text{C}$

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage*	$t_p = 2\text{ s}$	6000	V
		AC Voltage	$t_p = 1\text{ min}$	2500	V
Creepage distance				min. 12,7	mm
Clearance				min. 12,7	mm
Comparative Tracking Index	CTI			> 200	

*100 % tested in production



Vincotech

Characteristic Values

Parameter	Symbol	Conditions						Value			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_c [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

Rectifier Diode

Static

Forward voltage	V_F				25	25 125		1,22 1,21	1,75	V
Reverse leakage current	I_r			1600		25 145			50 1100	µA

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						1,59		K/W
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Vincotech

Characteristic Values

Parameter	Symbol	Conditions						Value			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_c [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

PFC Switch

Static

Drain-source on-state resistance	$r_{DS(on)}$		10		26	25 125		72 150	80		mΩ
Gate-source threshold voltage	$V_{GS(th)}$	$V_{GS} = V_{DS}$			0,00172	25	2,4	3	3,6		V
Gate to Source Leakage Current	I_{GSS}		20	0		25			100		nA
Zero Gate Voltage Drain Current	I_{DSS}		0	600		25			5		µA
Internal gate resistance	r_g							0,85			Ω
Gate charge	Q_g							170			
Gate to source charge	Q_{GS}		0/10	480	25,8	25		21			nC
Gate to drain charge	Q_{GD}							87			
Short-circuit input capacitance	C_{iss}							3800			
Short-circuit output capacitance	C_{oss}	$f = 1\text{MHz}$	0	100		25		215			pF
Reverse transfer capacitance	C_{rss}							35			

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						1,09			K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$					25 125 150		38 44 25			
Rise time	t_r	$R_{goff} = 8 \Omega$ $R_{gon} = 8 \Omega$				25 125 150		5 6 7			
Turn-off delay time	$t_{d(off)}$					25 125 150		130 136 250			
Fall time	t_f					25 125 150		11 14 5			
Turn-on energy (per pulse)	E_{on}	$Q_{fwd} = 0,3 \mu\text{C}$ $Q_{rfwd} = 0,6 \mu\text{C}$ $Q_{rfwd} = 0,8 \mu\text{C}$				25 125 150		0,136 0,208 0,345			
Turn-off energy (per pulse)	E_{off}					25 125 150		0,042 0,053 0,120			mWs



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Characteristic Values

Parameter	Symbol	Conditions						Value			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_c [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

PFC Diode

Static

Forward voltage	V_F				30	25 125 150		2,26 1,67 1,55	2,78	V
Reverse leakage current	I_r			600		25			10	μA

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						1,81		K/W
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Dynamic

Peak recovery current	I_{RRM}	$di/dt = 2946 \text{ A}/\mu\text{s}$ $di/dt = 2625 \text{ A}/\mu\text{s}$ $di/dt = 2104 \text{ A}/\mu\text{s}$	10/-5	400	15	25		29		A
Reverse recovery time	t_{rr}					125		43		
Recovered charge	Q_r					150		45		
Recovered charge	Q_r	$di/dt = 2946 \text{ A}/\mu\text{s}$ $di/dt = 2625 \text{ A}/\mu\text{s}$ $di/dt = 2104 \text{ A}/\mu\text{s}$	10/-5	400	15	25		14		
Reverse recovered energy	E_{rec}					125		25		ns
Reverse recovered energy	E_{rec}					150		30		
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					25		0,253		
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					125		0,585		μC
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					150		0,787		
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					25		0,046		
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					125		0,185		mWs
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					150		0,125		
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					25		8586		
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					125		6089		$\text{A}/\mu\text{s}$
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					150		4643		

Capacitor (PFC)

Capacitance	C							100		nF
Tolerance							-10		+10	%

PFC Shunt

Resistance	R							10		$\text{m}\Omega$
Temperature coefficient	t_c					20 - 60			30	ppm/K
Internal heat resistance	R_{thi}								10	K/W



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Characteristic Values

Parameter	Symbol	Conditions						Value			Unit	
		V_{GE} [V]	V_{CE} [V]	I_c [A]	I_D [A]	T_j [°C]	V_{GS} [V]	V_{DS} [V]	I_F [A]	Min	Typ	Max

Inverter Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}$			0,00021	25		5	5,8	6,5	V
Collector-emitter saturation voltage	V_{CESat}		15		15	25	150	1,1	1,59 1,85	1,9	V
Collector-emitter cut-off current	I_{CES}		0	600		25				28	µA
Gate-emitter leakage current	I_{GES}		20	0		25				300	nA
Internal gate resistance	r_g							none			Ω
Input capacitance	C_{ies}	$f = 1 \text{ MHz}$	0	25	25	25	25	860	55	24	pF
Output capacitance	C_{oes}										
Reverse transfer capacitance	C_{res}										
Gate charge	Q_g										

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{\text{paste}} = 3,4 \text{ W/mK}$ (PSX)							1,83		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{goff} = 32 \Omega$ $R_{gon} = 32 \Omega$	± 15	400	15	25		102			ns
Rise time	t_r					25		29			
Turn-off delay time	$t_{d(off)}$					25		31			
Fall time	t_f					25		31			
Turn-on energy (per pulse)	E_{on}	$Q_{fFWD} = 0,6 \mu\text{C}$ $Q_{fFWD} = 1,3 \mu\text{C}$ $Q_{fFWD} = 1,5 \mu\text{C}$	± 15	400	15	25		157			mWs
Turn-off energy (per pulse)	E_{off}					25		179			
						25		181			
						25		62			
						25		72			
						25		85			
						25		0,482			
						25		0,678			
						25		0,693			
						25		0,426			
						25		0,553			
						25		0,598			



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Characteristic Values

Parameter	Symbol	Conditions						Value			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_c [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

Inverter Diode

Forward voltage	V_F				15	25 150		1,60 1,51	1,95	V
Reverse leakage current	I_r			600		25			27	µA

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						2,75		K/W
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Dynamic

Peak recovery current	I_{RRM}	$di/dt = 446 \text{ A/}\mu\text{s}$ $di/dt = 490 \text{ A/}\mu\text{s}$ $di/dt = 382 \text{ A/}\mu\text{s}$	± 15	400	15	25		6		A
Reverse recovery time	t_{rr}					25		231		ns
Recovered charge	Q_r					125		309		
						150		350		
Reverse recovered energy	E_{rec}					25		0,646		µC
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					125		1,30		
						150		1,53		
						25		0,178		mWs
						125		0,353		
						150		0,431		
						25		21		A/µs
						125		43		
						150		51		

Thermistor

Rated resistance	R				25		22		kΩ
Deviation of R_{100}	$\Delta_{R/R}$	$R_{100} = 1484 \Omega$			100	-5	5	%	
Power dissipation	P				25		5		mW
Power dissipation constant					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. ±1 %			25		3962		K
B-value	$B_{(25/100)}$	Tol. ±1 %			25		4000		K
Vincotech NTC Reference								I	



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Rectifier Diode Characteristics

figure 1.
Typical forward characteristics

FWD

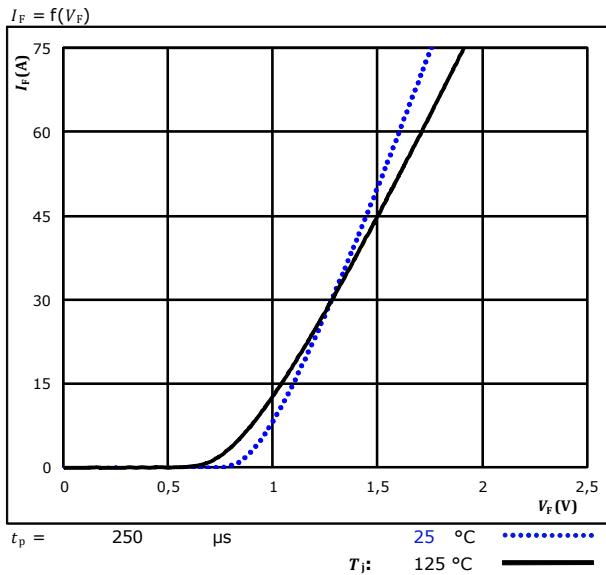
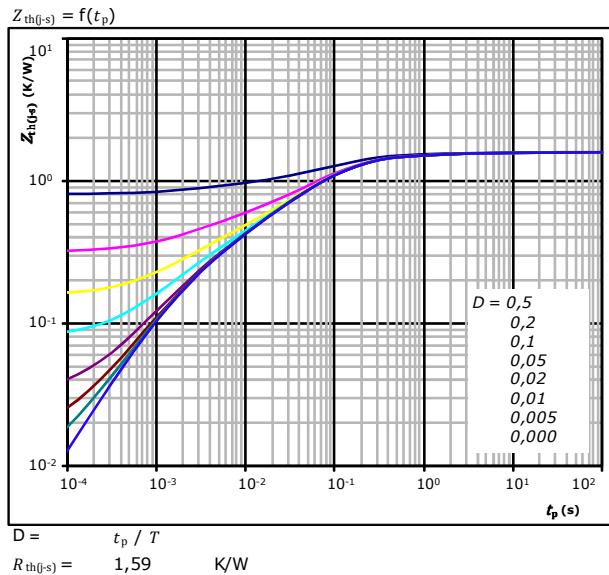


figure 2.
Transient thermal impedance as a function of pulse width

FWD



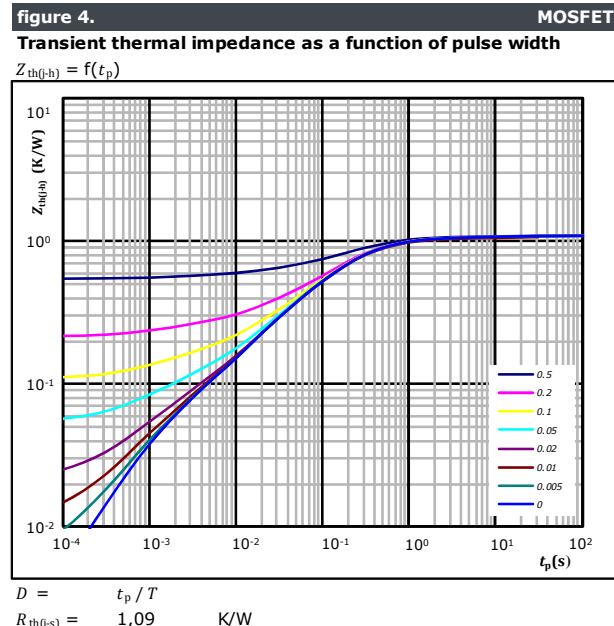
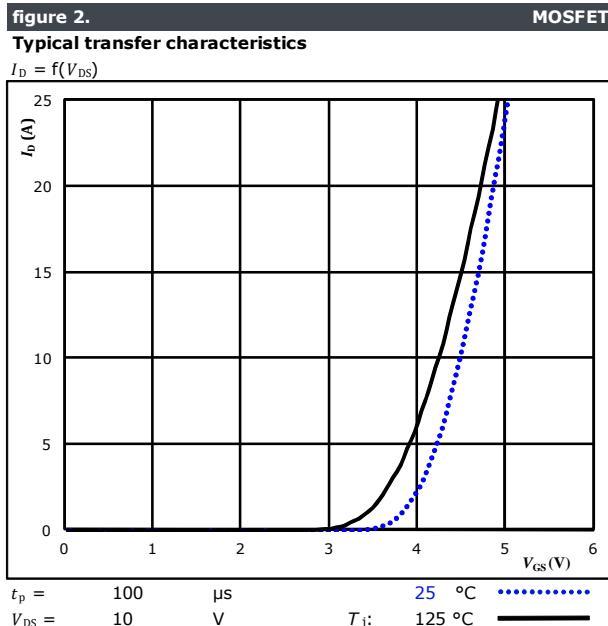
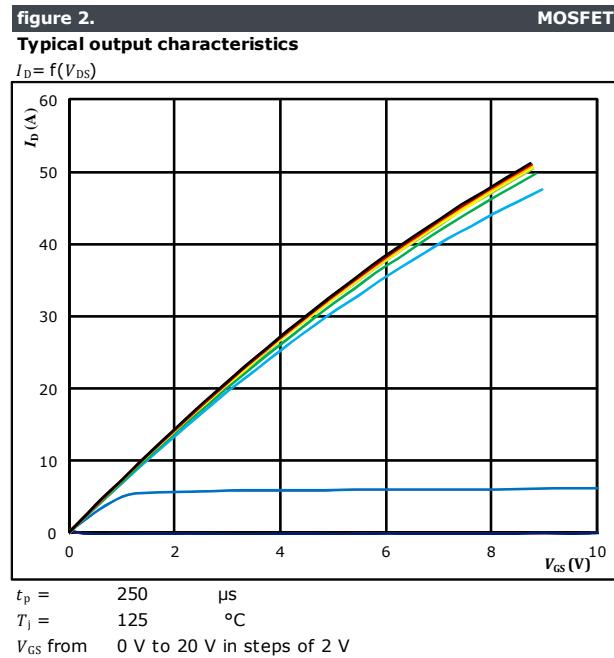
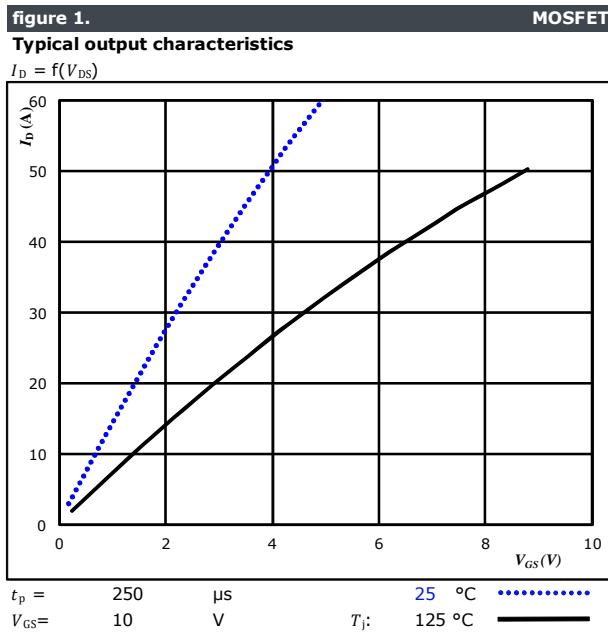
Diode thermal model values

R (K/W)	τ (s)
3,44E-02	9,66E+00
1,12E-01	1,22E+00
5,81E-01	1,45E-01
4,89E-01	5,05E-02
2,38E-01	9,26E-03
1,22E-01	1,79E-03
1,22E-01	1,79E-03



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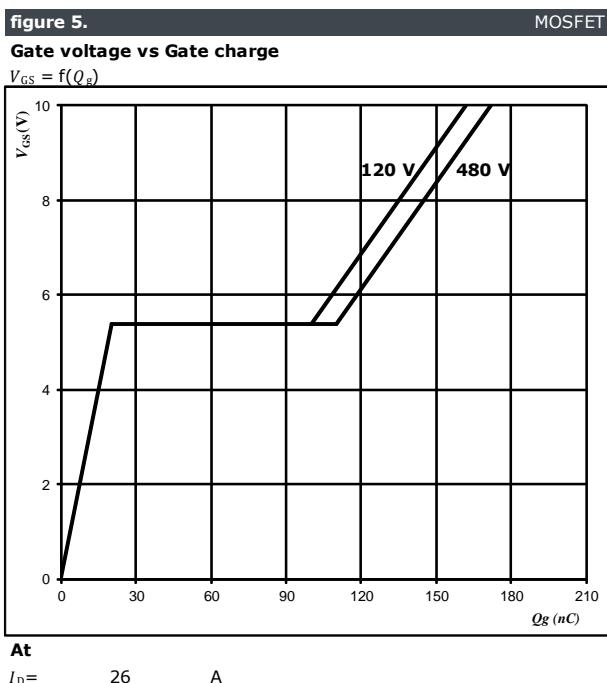
PFC Switch Characteristics





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PFC Switch Characteristics





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PFC Diode Characteristics

figure 1.
Typical forward characteristics

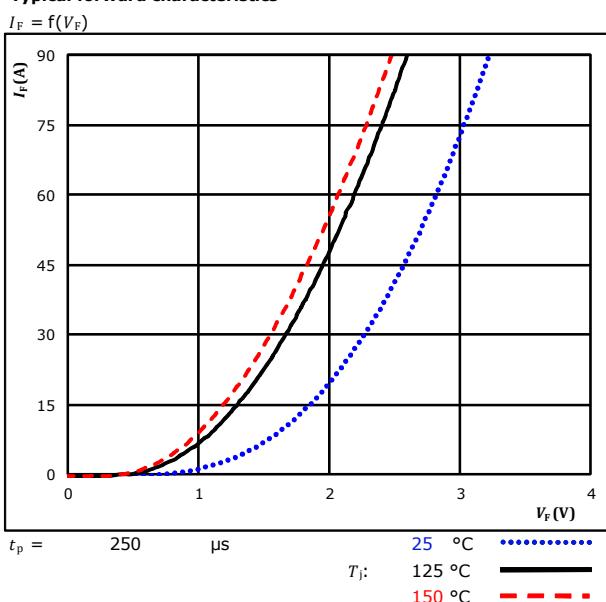
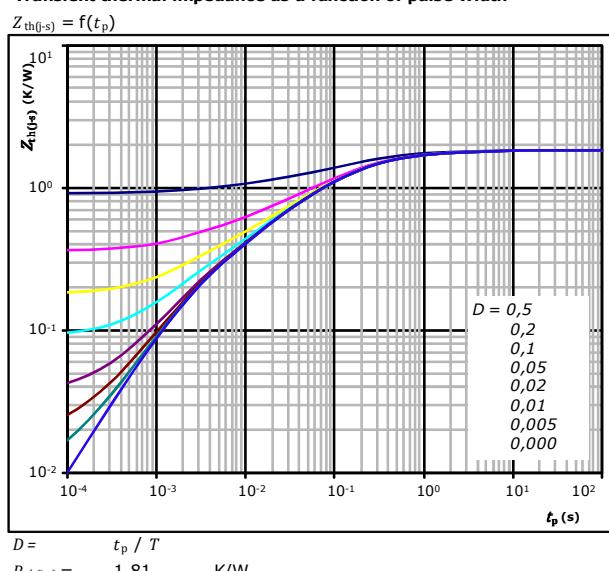


figure 2.
Transient thermal impedance as a function of pulse width



$D = t_p / T$

$$R_{th(s)} = 1,81 \text{ K/W}$$

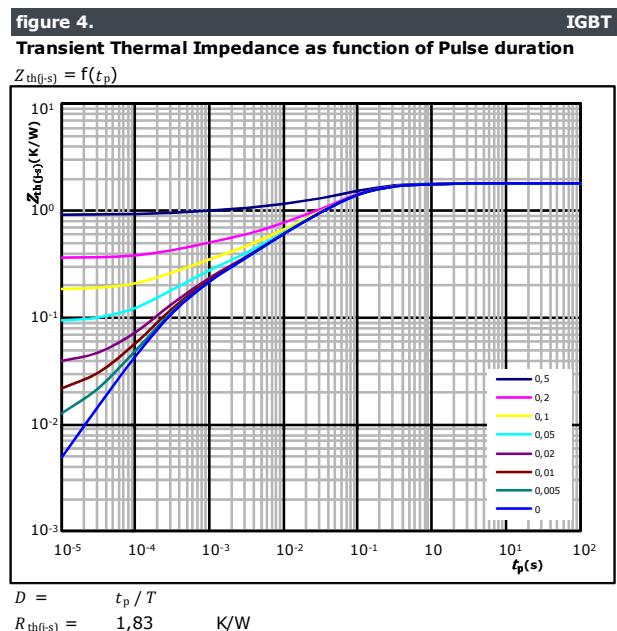
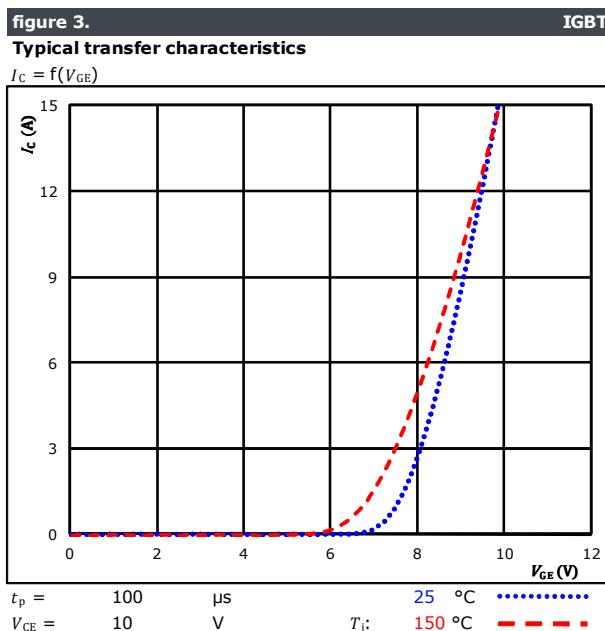
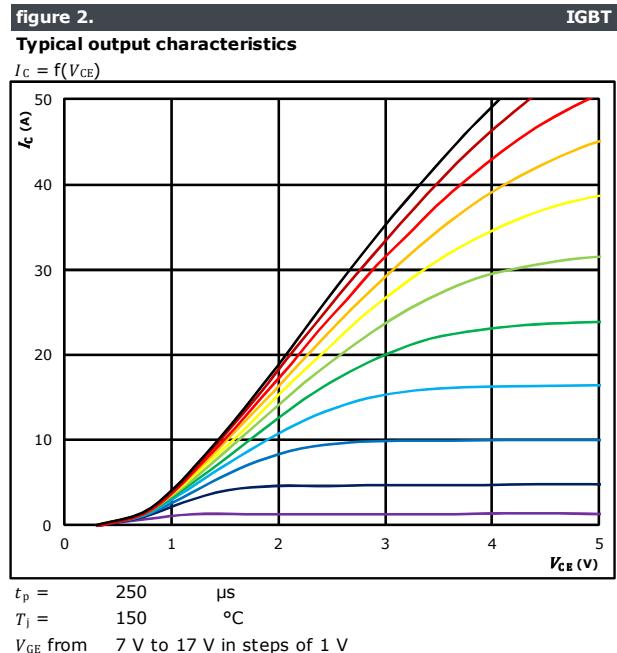
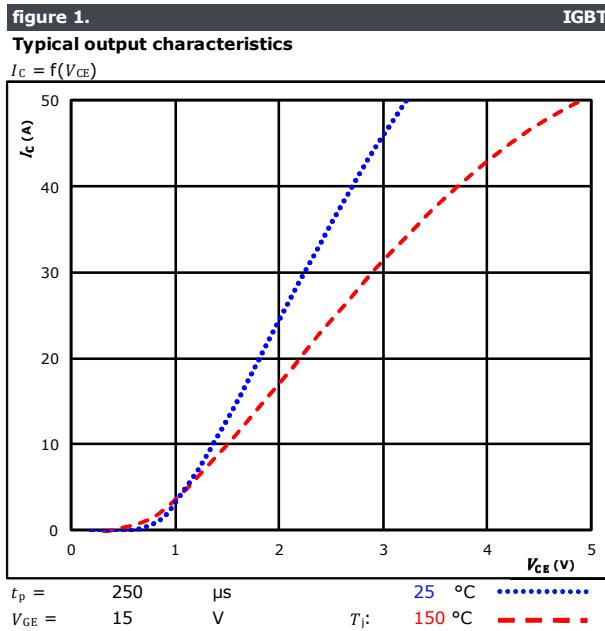
FWD thermal model values

R (K/W)	τ (s)
1,53E-01	3,12E+00
5,19E-01	3,17E-01
6,76E-01	7,98E-02
3,13E-01	1,47E-02
1,53E-01	2,20E-03



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Inverter Switch Characteristics



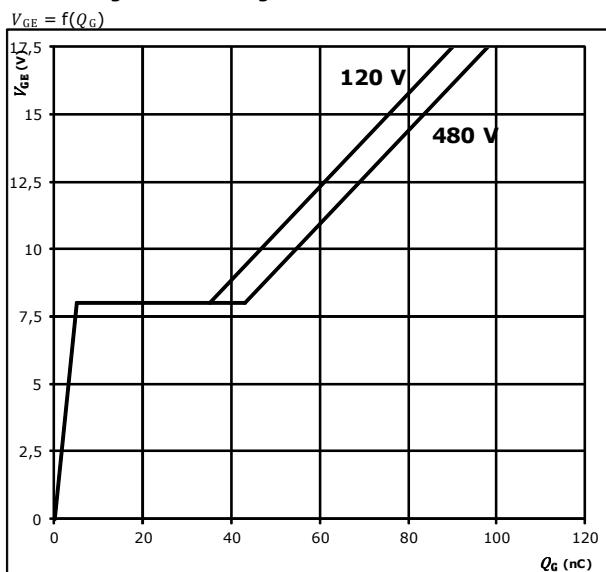


Vincotech

Inverter Switch Characteristics

figure 5. IGBT

Gate voltage vs Gate charge

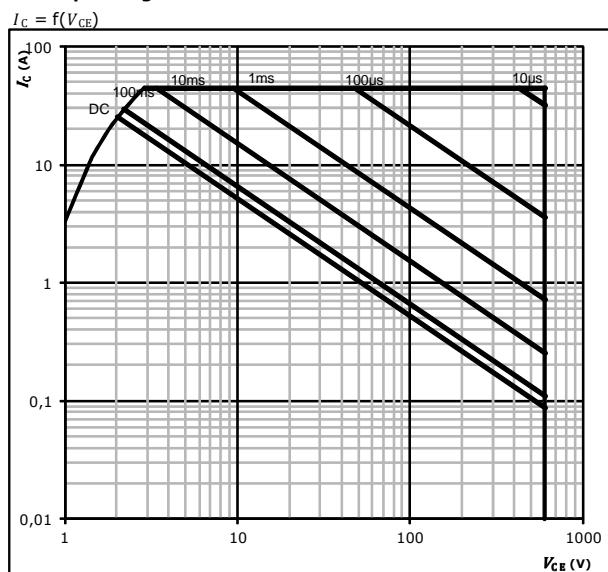


At

$$I_C = 15 \text{ A}$$

figure 6. IGBT

Safe operating area

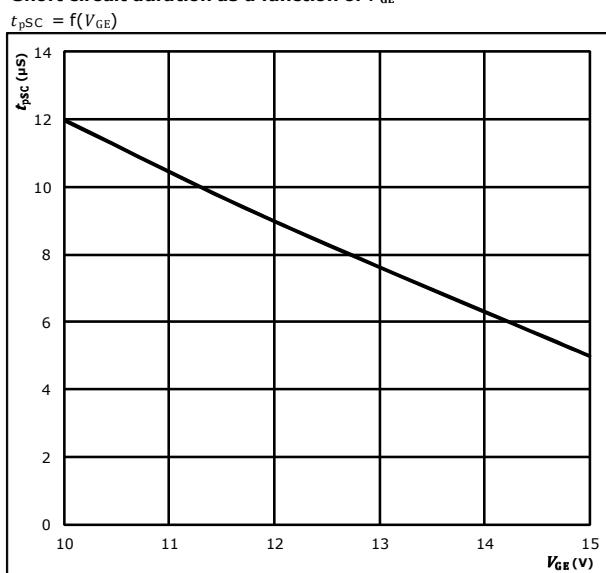


At

$$\begin{aligned} D &= \text{single pulse} \\ T_s &= 80 \text{ }^{\circ}\text{C} \\ V_{GE} &= \pm 15 \text{ V} \\ T_j &= T_{jmax} \end{aligned}$$

figure 7. IGBT

Short circuit duration as a function of V_{GE}

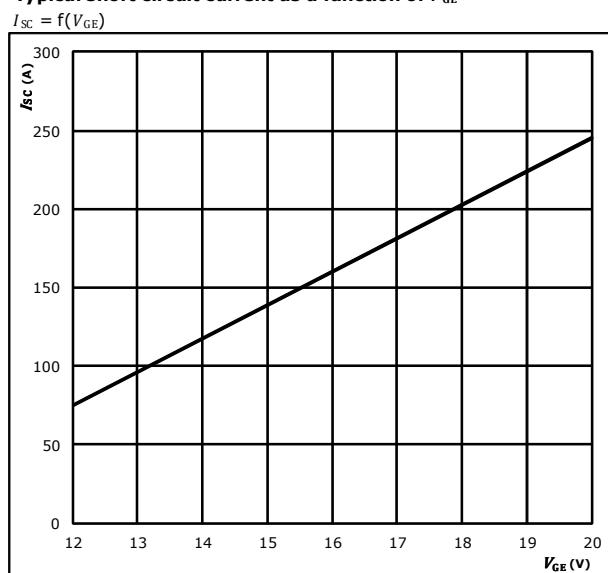


At

$$\begin{aligned} V_{CE} &= 600 \text{ V} \\ T_j \leq & 175 \text{ }^{\circ}\text{C} \end{aligned}$$

figure 8. IGBT

Typical short circuit current as a function of V_{GE}



At

$$\begin{aligned} V_{CE} \leq & 600 \text{ V} \\ T_j \leq & 175 \text{ }^{\circ}\text{C} \end{aligned}$$



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Inverter Diode Characteristics

figure 1.
Typical forward characteristics

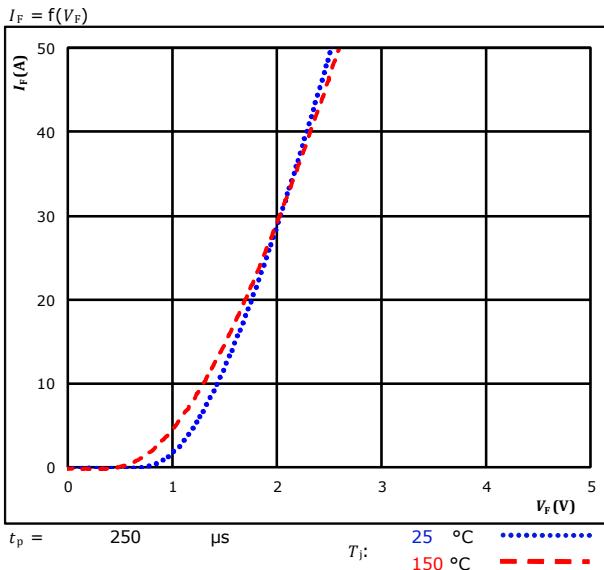
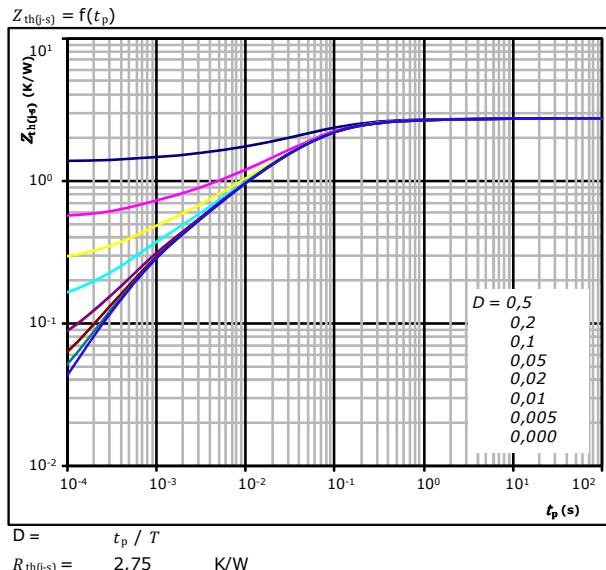


figure 2.
Transient thermal impedance as a function of pulse width



FWD thermal model values

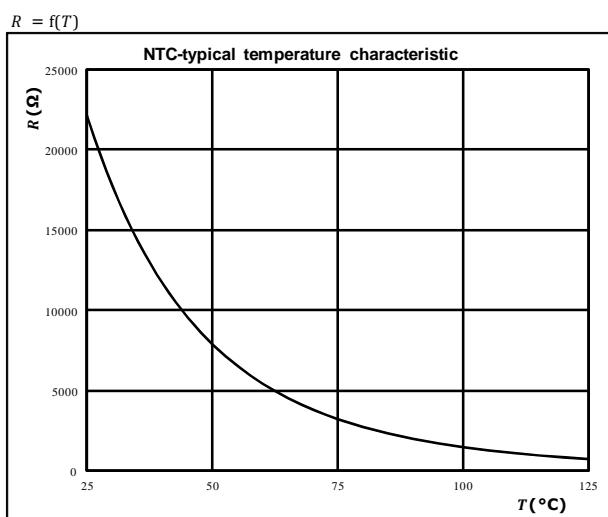
R (K/W)	τ (s)
1,03E-01	3,14E+00
3,03E-01	2,74E-01
1,23E+00	6,07E-02
5,94E-01	1,63E-02
3,18E-01	4,11E-03
2,02E-01	6,37E-04



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Thermistor Characteristics

figure 1. Thermistor
Typical NTC characteristic as a function of temperature





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PFC Switching Characteristics

figure 1. MOSFET

Typical switching energy losses as a function of drain current

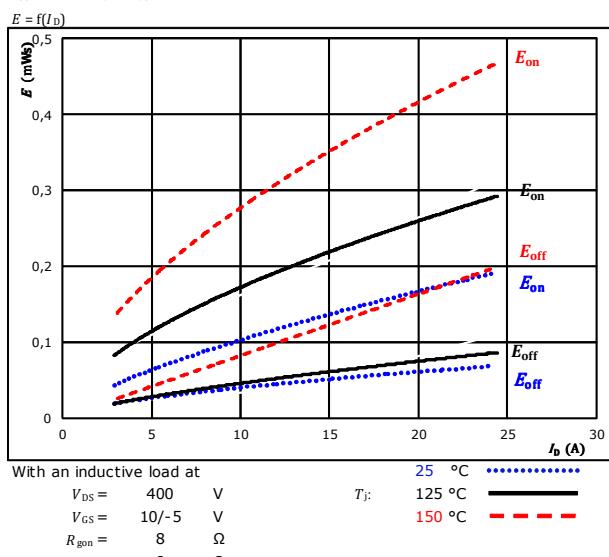


figure 2. MOSFET

Typical switching energy losses as a function of gate resistor

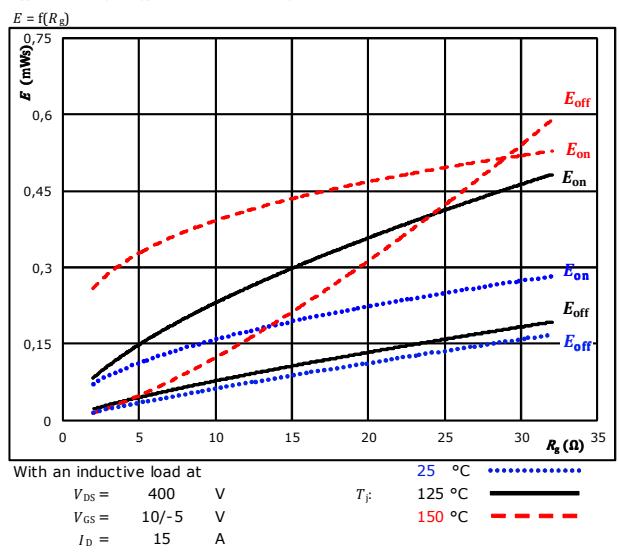


figure 3. FWD

Typical reverse recovered energy loss as a function of drain current

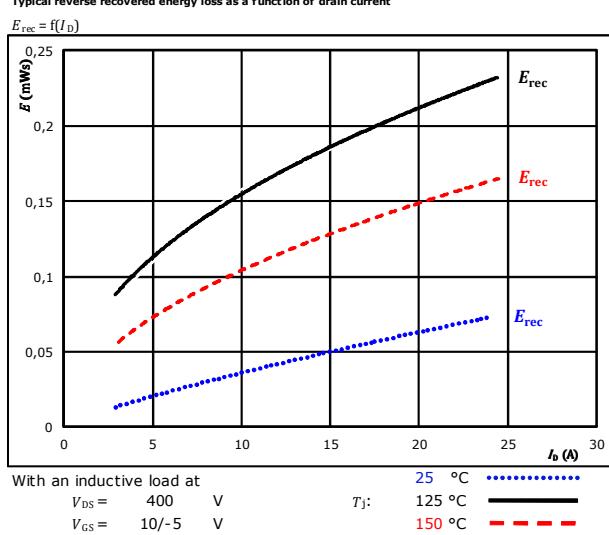
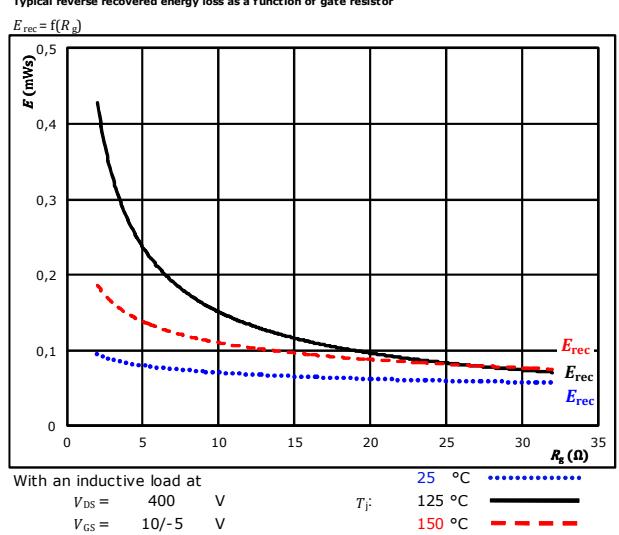


figure 4. FWD

Typical reverse recovered energy loss as a function of gate resistor

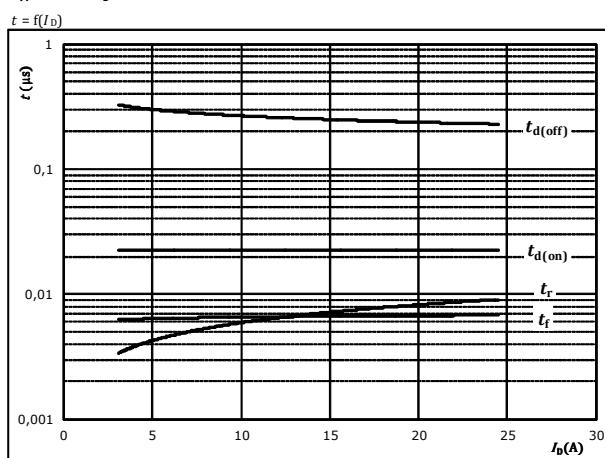




Vincotech

PFC Switching Characteristics

figure 5.
Typical switching times as a function of drain current



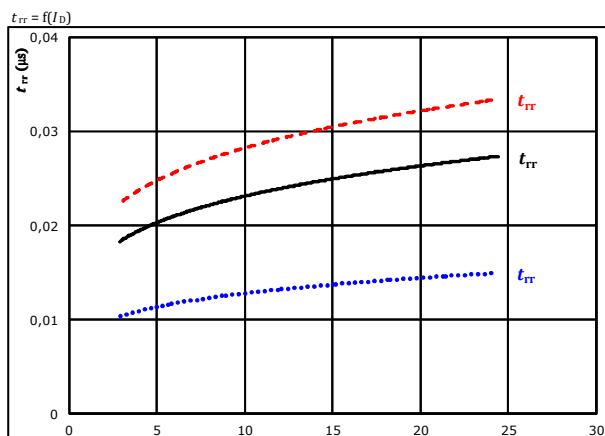
With an inductive load at

$T_J = 150^\circ\text{C}$
 $V_{DS} = 400 \text{ V}$
 $V_{GS} = 10/-5 \text{ V}$
 $R_{gon} = 8 \Omega$
 $R_{goff} = 8 \Omega$

figure 7.

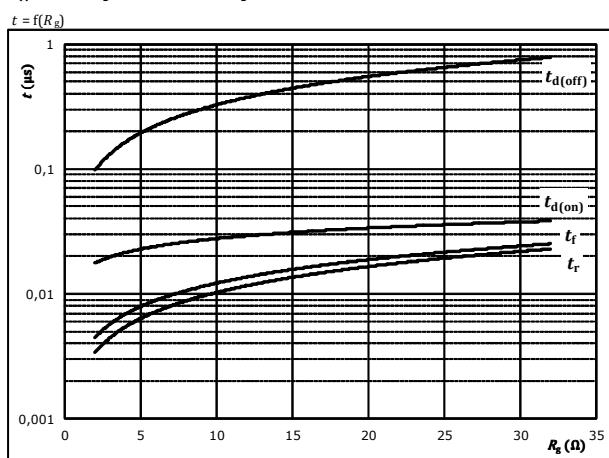
FWD

Typical reverse recovery time as a function of drain current



At $V_{DS} = 400 \text{ V}$ $V_{GS} = 10/-5 \text{ V}$ $R_{gon} = 8 \Omega$ $T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$ $T_J = 150^\circ\text{C}$

figure 6.
Typical switching times as a function of gate resistor



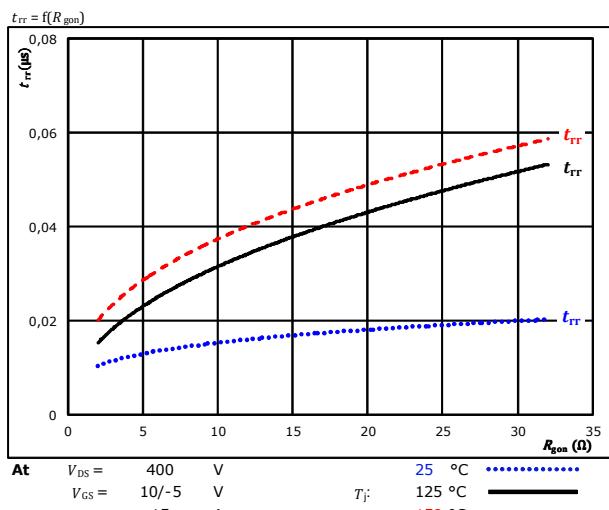
With an inductive load at

$T_J = 150^\circ\text{C}$
 $V_{DS} = 400 \text{ V}$
 $V_{GS} = 10/-5 \text{ V}$
 $I_D = 15 \text{ A}$

figure 8.

FWD

Typical reverse recovery time as a function of MOSFET turn on gate resistor

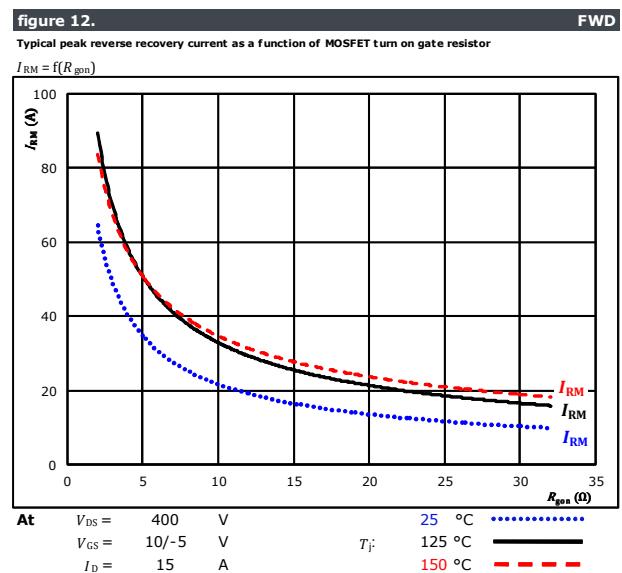
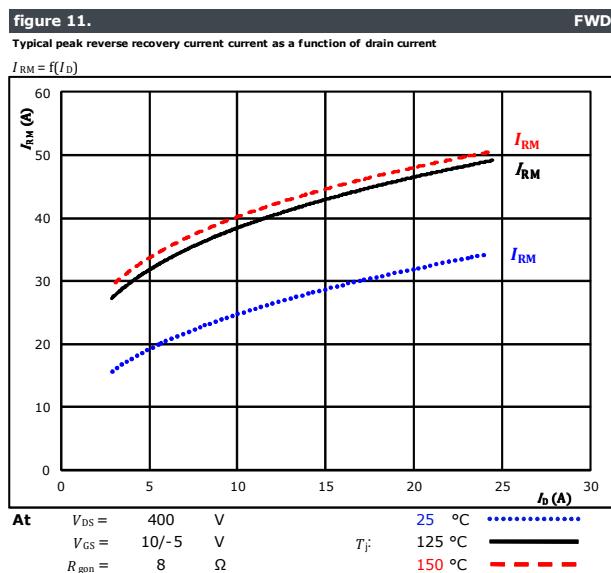
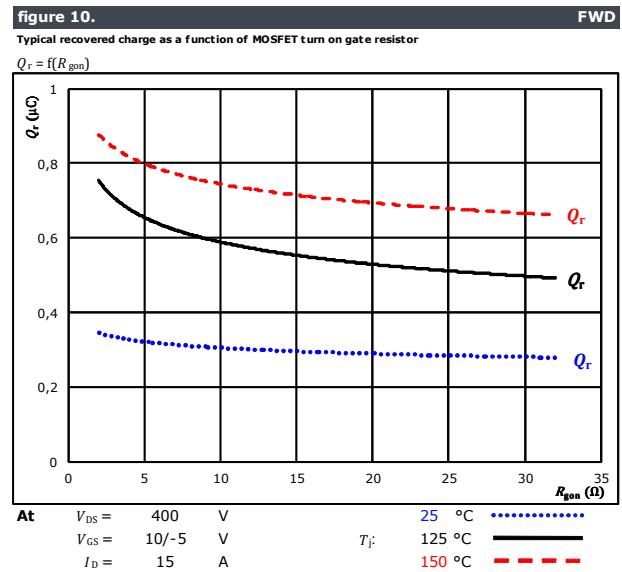
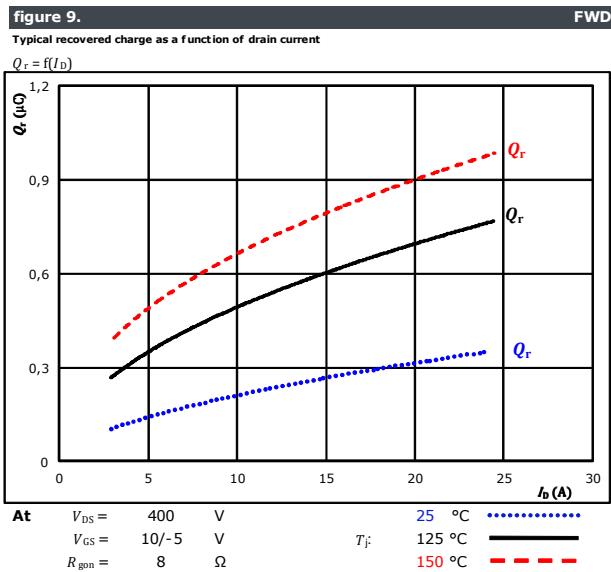


At $V_{DS} = 400 \text{ V}$ $V_{GS} = 10/-5 \text{ V}$ $I_D = 15 \text{ A}$ $T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$ $T_J = 150^\circ\text{C}$



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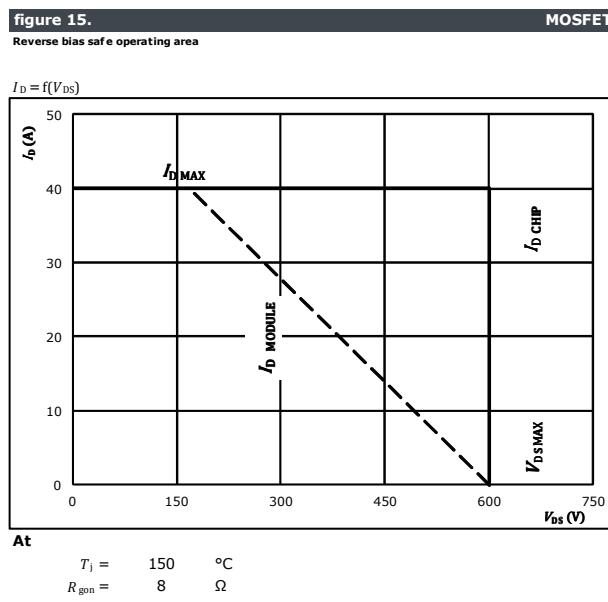
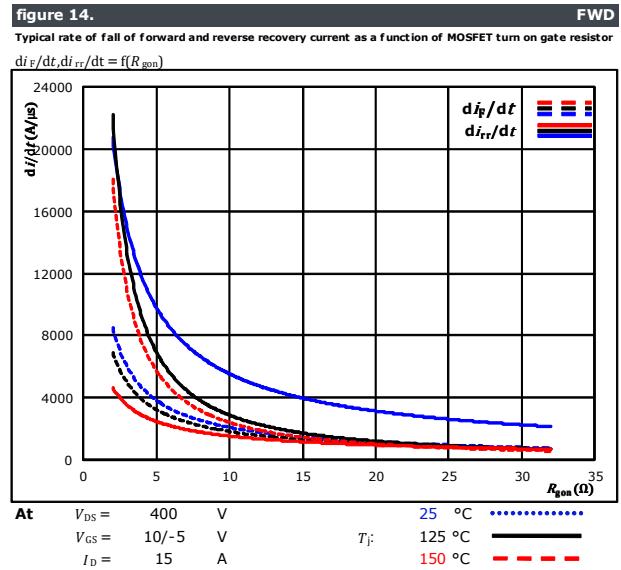
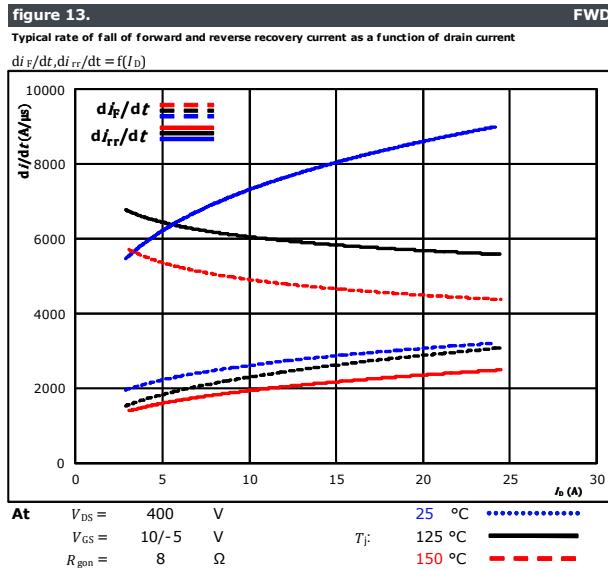
PFC Switching Characteristics





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PFC Switching Characteristics





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PFC Switching Definitions

General conditions

T_j	=	125 °C
R_{gon}	=	8 Ω
R_{goff}	=	8 Ω

figure 1.

MOSFET

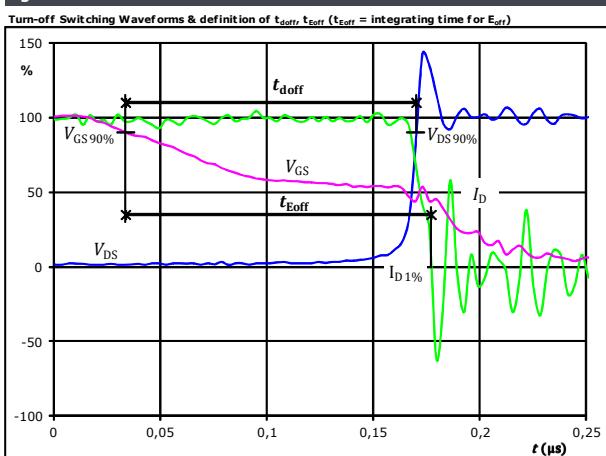


figure 3.

MOSFET

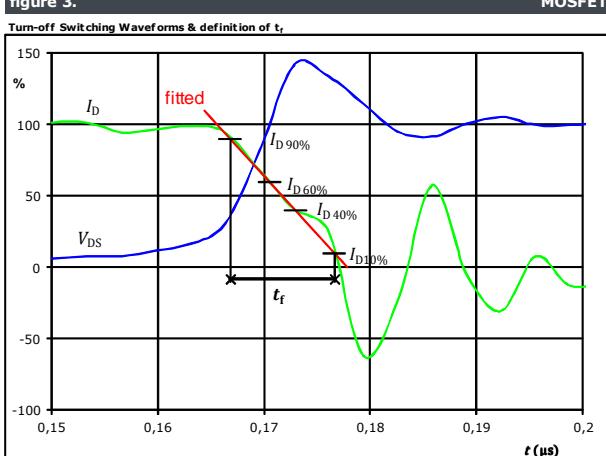


figure 2.

MOSFET

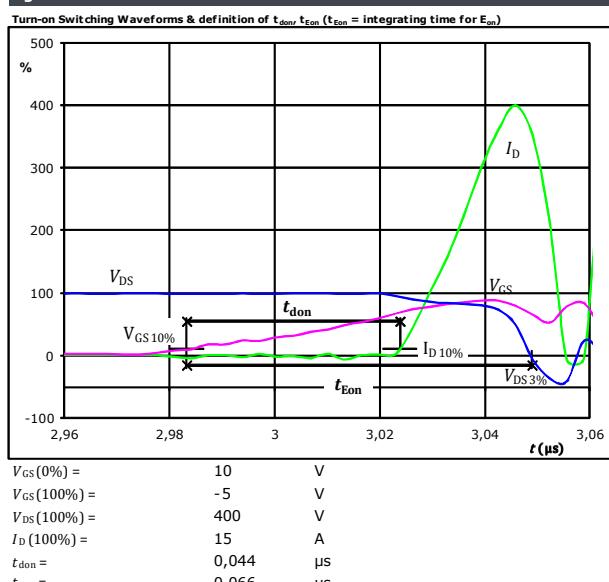
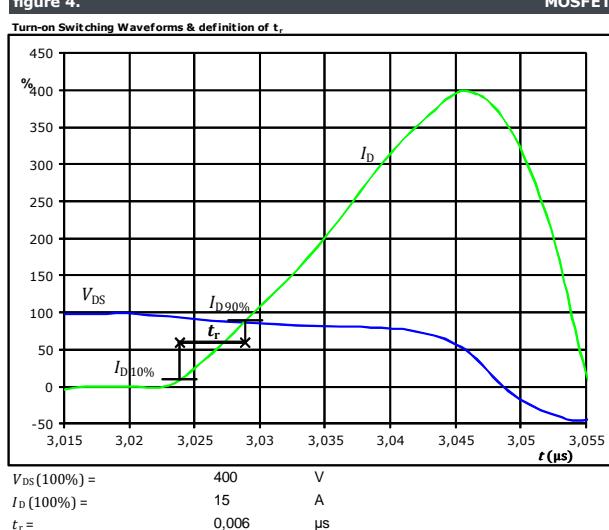


figure 4.

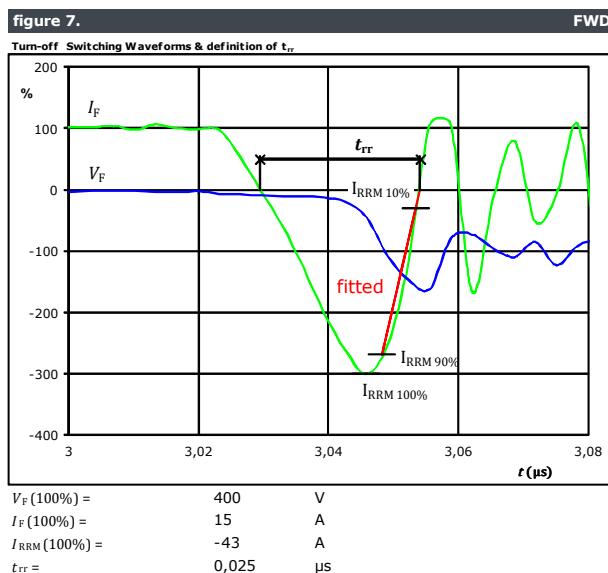
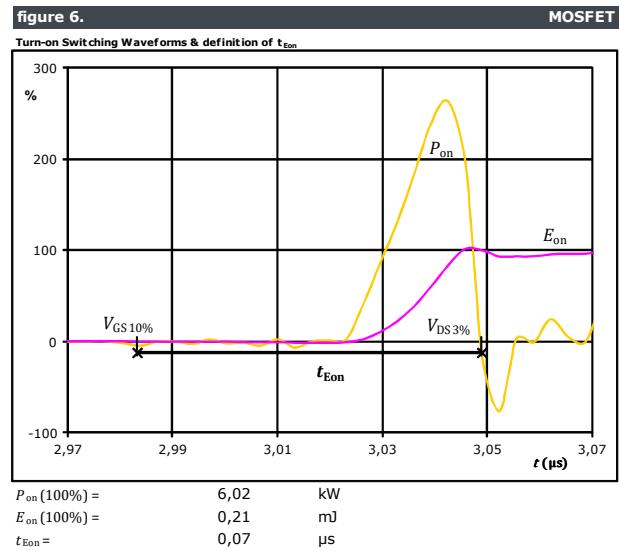
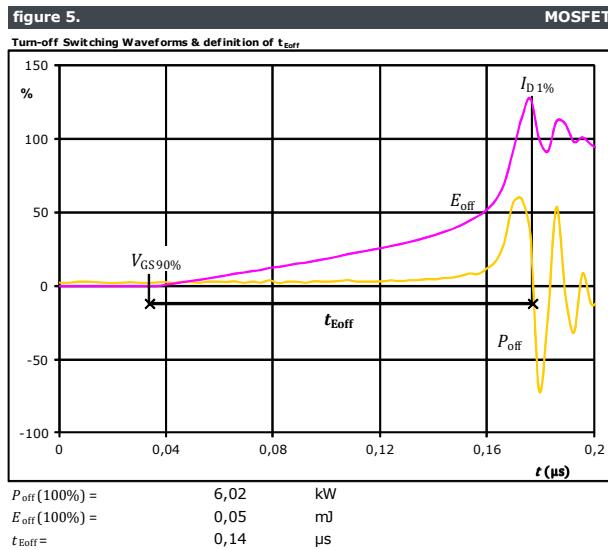
MOSFET





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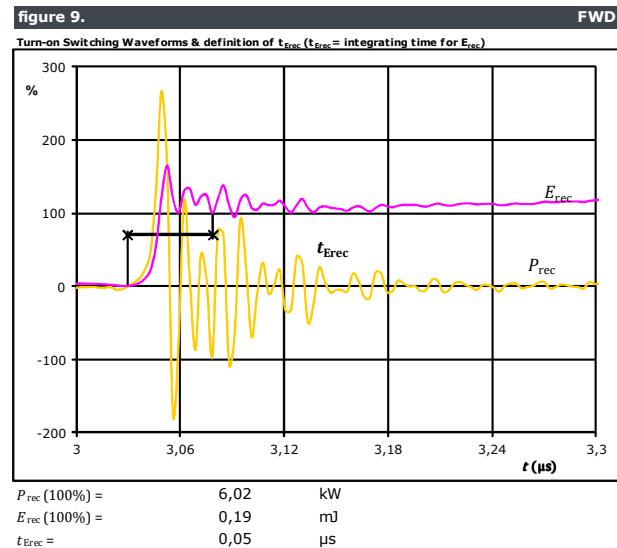
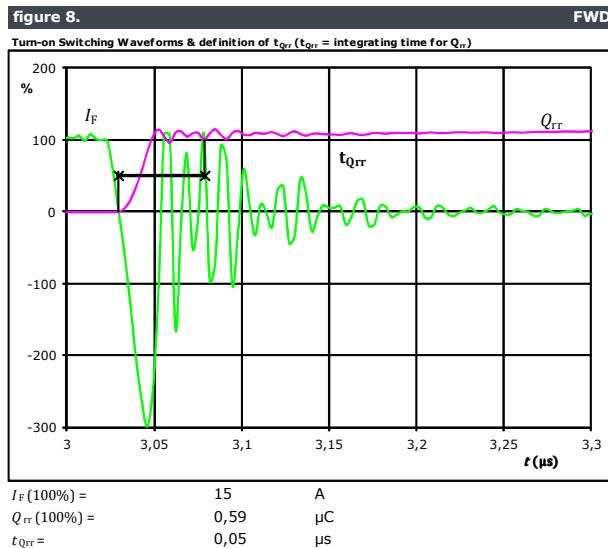
PFC Switching Characteristics





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PFC Switching Characteristics





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Inverter Switching Characteristics

figure 1.

Typical switching energy losses as a function of collector current

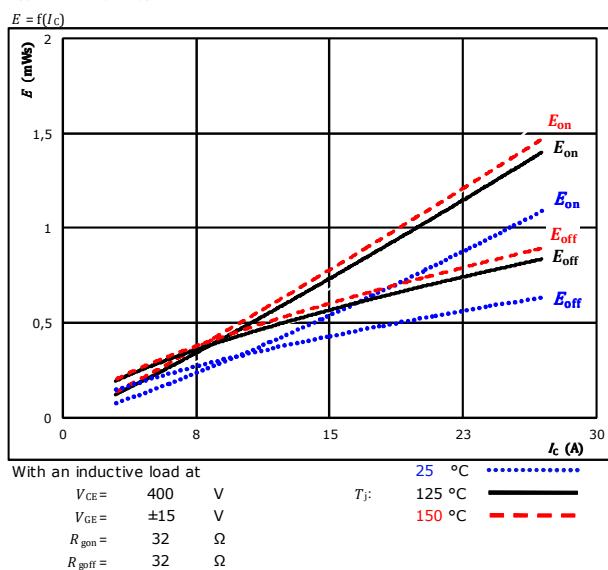


figure 2.

Typical switching energy losses as a function of gate resistor

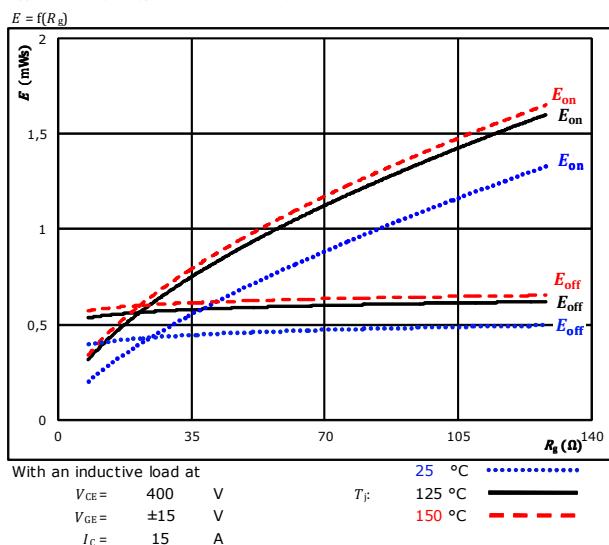


figure 3.

Typical reverse recovered energy loss as a function of collector current

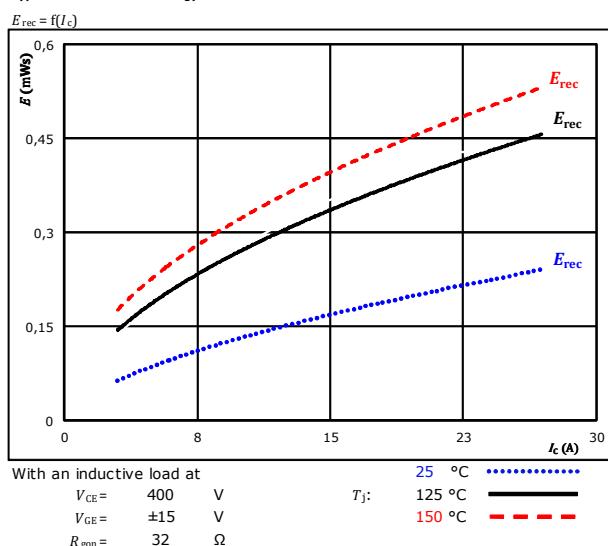
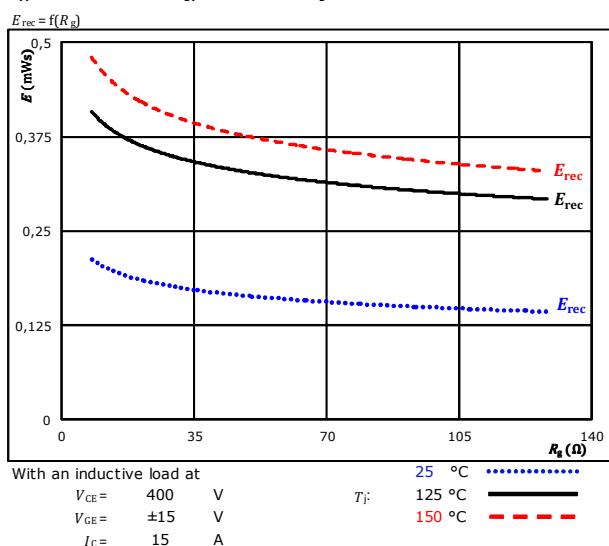


figure 4.

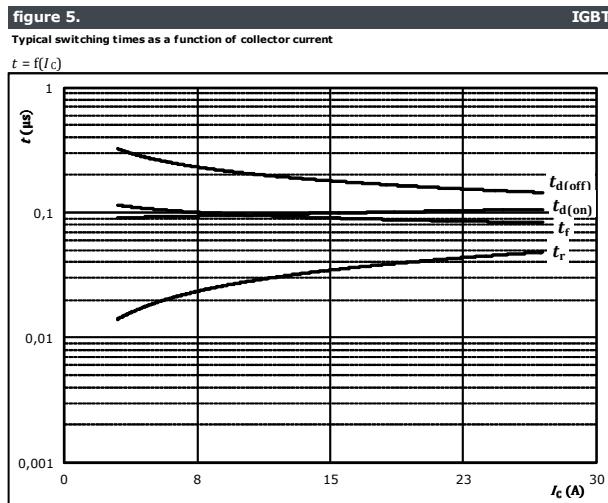
Typical reverse recovered energy loss as a function of gate resistor





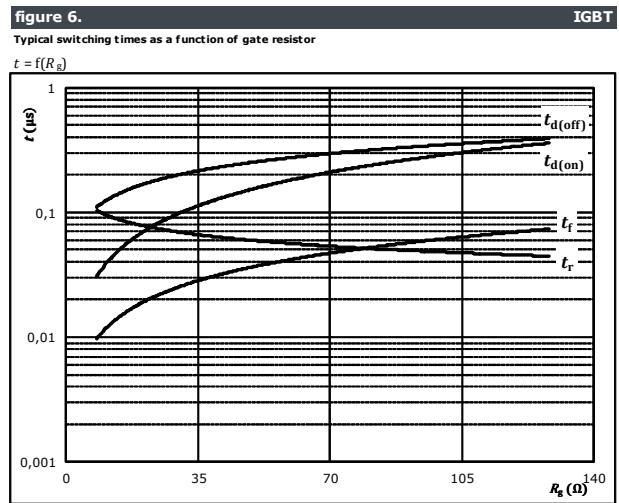
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Inverter Switching Characteristics



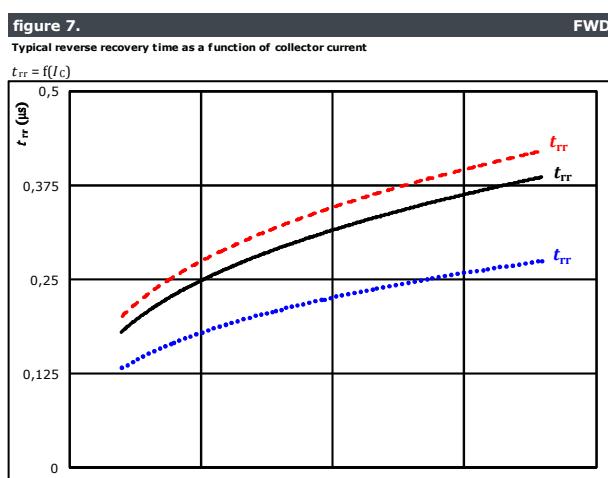
With an inductive load at

$T_J =$	150	°C
$V_{CE} =$	400	V
$V_{GE} =$	±15	V
$R_{gon} =$	32	Ω
$R_{goff} =$	32	Ω

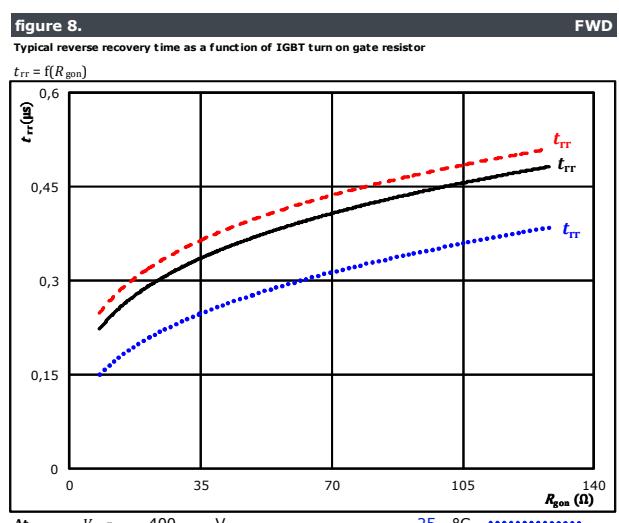


With an inductive load at

$T_J =$	150	°C
$V_{CE} =$	400	V
$V_{GE} =$	±15	V
$I_C =$	15	A



At	$V_{CE} =$	400	V	25 °C
	$V_{GE} =$	±15	V	$T_J =$	125 °C
	$R_{gon} =$	32	Ω		150 °C

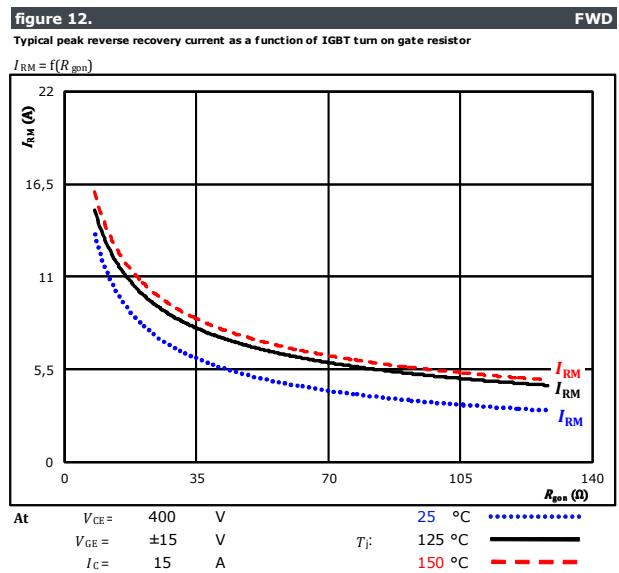
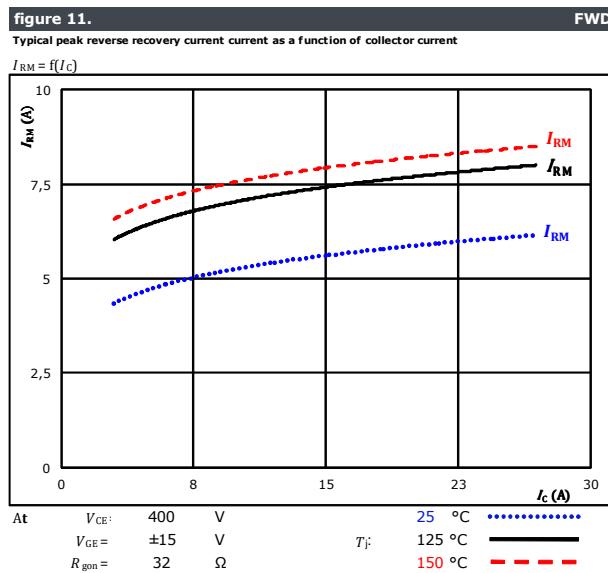
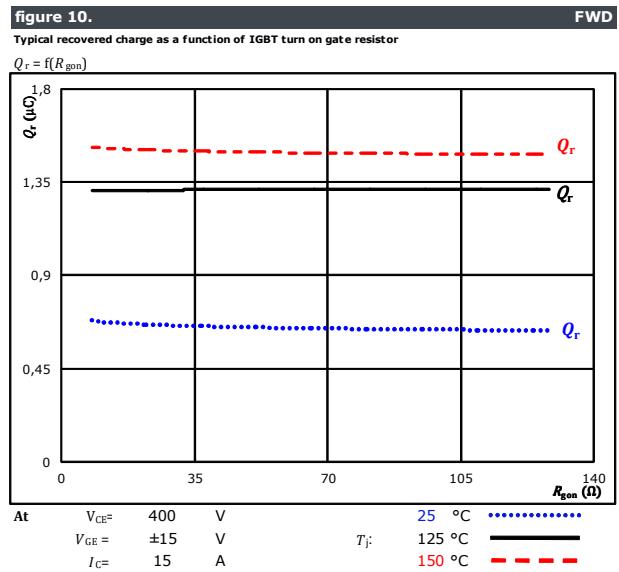
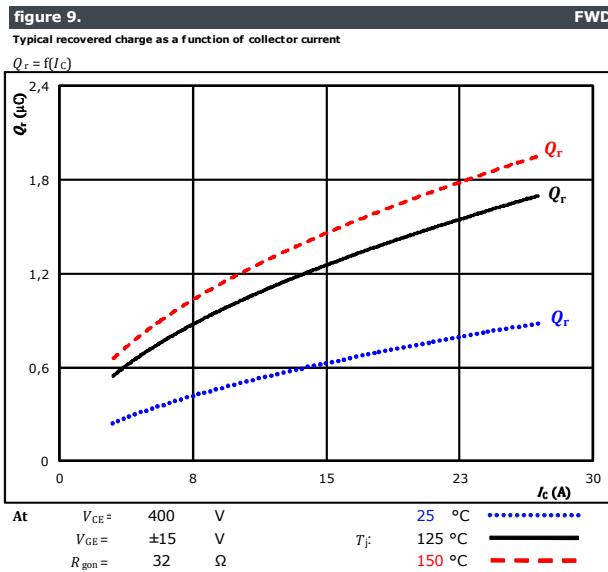


At	$V_{CE} =$	400	V	25 °C
	$V_{GE} =$	±15	V	$T_J =$	125 °C
	$I_C =$	15	A		150 °C



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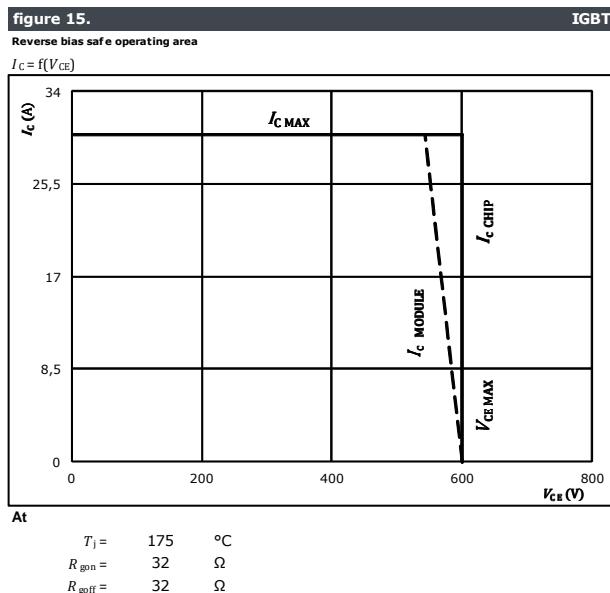
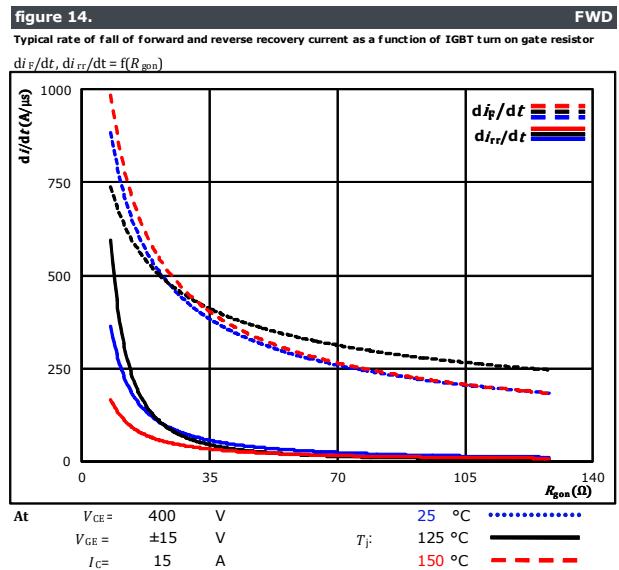
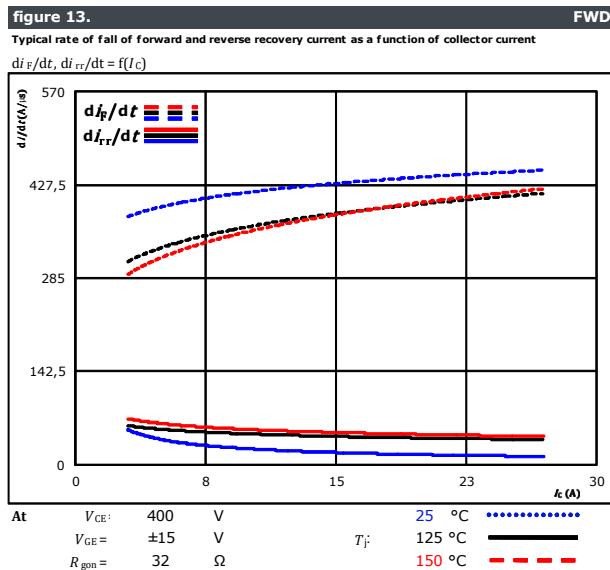
Inverter Switching Characteristics





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Inverter Switching Characteristics





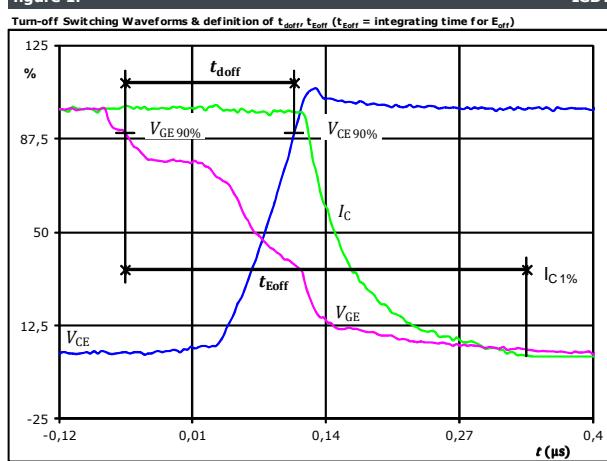
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Inverter Switching Definitions

General conditions

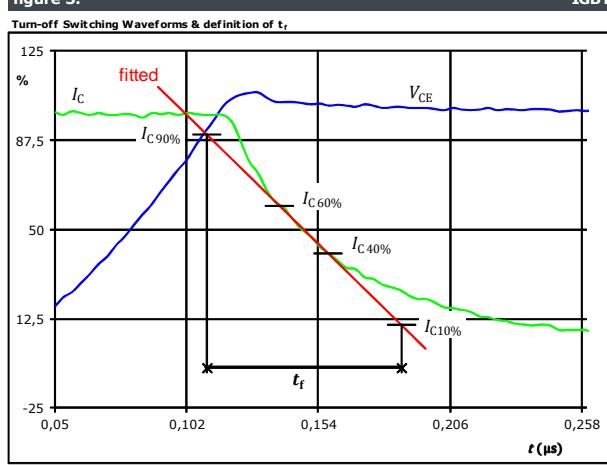
T_j	=	125 °C
R_{gon}	=	32 Ω
R_{goff}	=	32 Ω

figure 1.



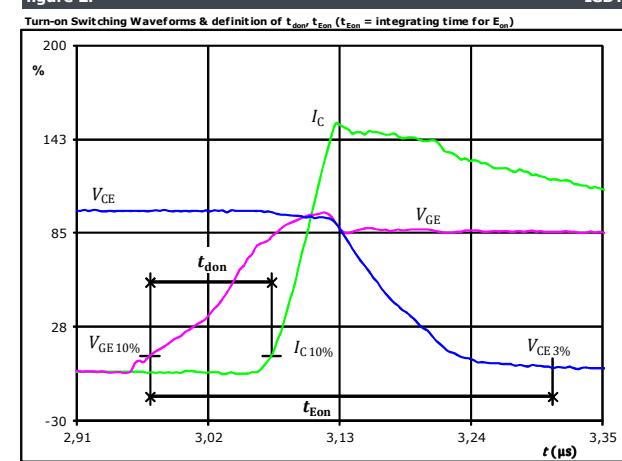
$V_{GE}(0\%) = -15$ V
 $V_{GE}(100\%) = 15$ V
 $V_C(100\%) = 400$ V
 $I_C(100\%) = 15$ A
 $t_{doff} = 0,179$ μs
 $t_{Eoff} = 0,392$ μs

figure 3.



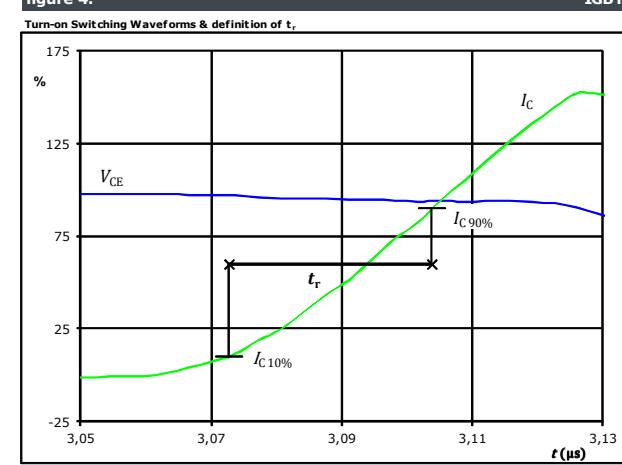
$V_C(100\%) = 400$ V
 $I_C(100\%) = 15$ A
 $t_f = 0,072$ μs

figure 2.



$V_{GE}(0\%) = -15$ V
 $V_{GE}(100\%) = 15$ V
 $V_C(100\%) = 400$ V
 $I_C(100\%) = 15$ A
 $t_{don} = 0,101$ μs
 $t_{Eon} = 0,337$ μs

figure 4.

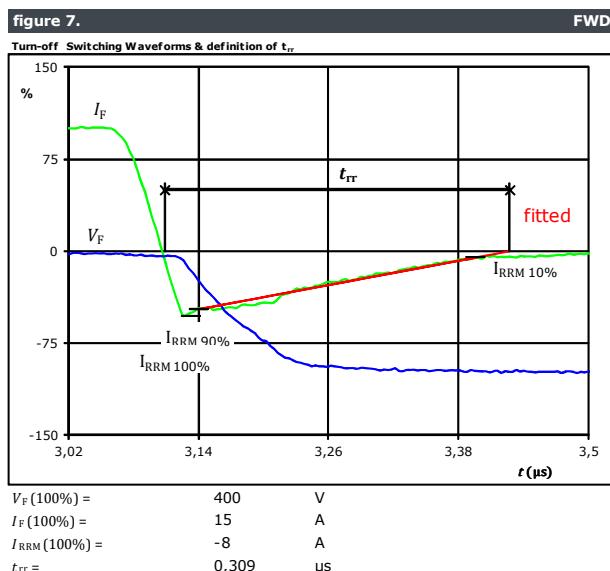
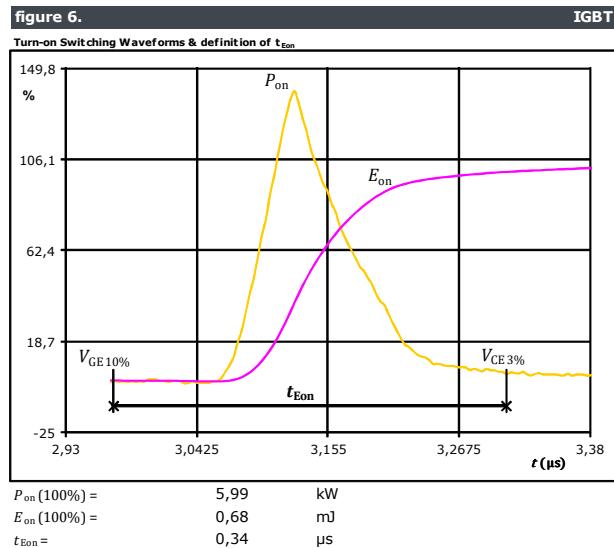
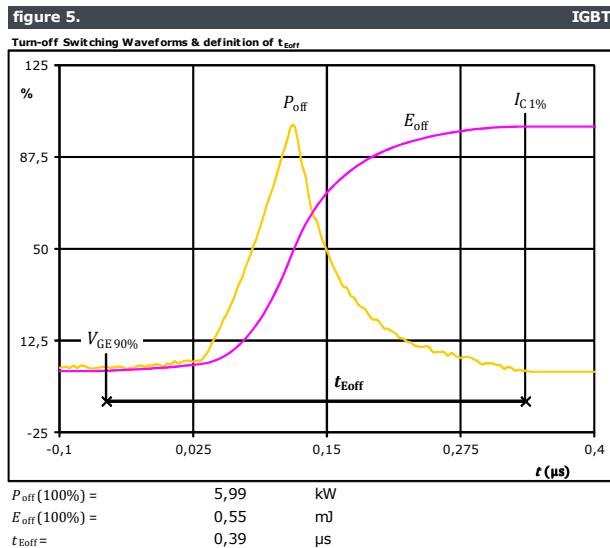


$V_C(100\%) = 400$ V
 $I_C(100\%) = 15$ A
 $t_r = 0,031$ μs



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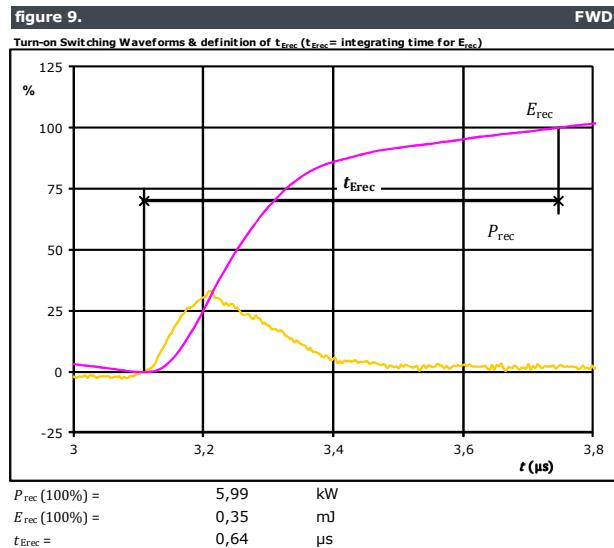
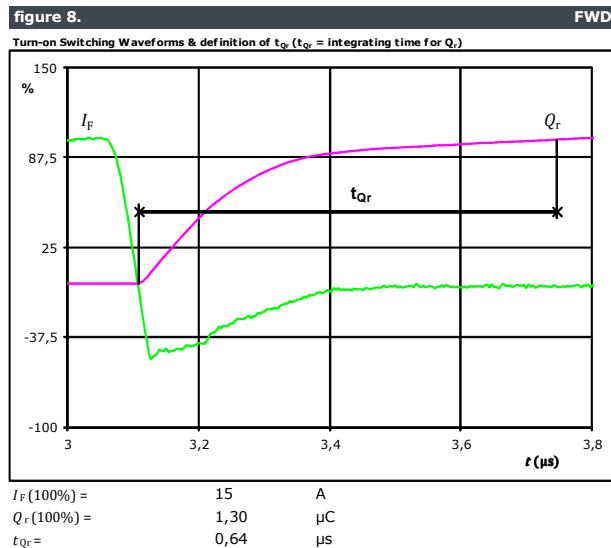
Inverter Switching Characteristics





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Inverter Switching Characteristics





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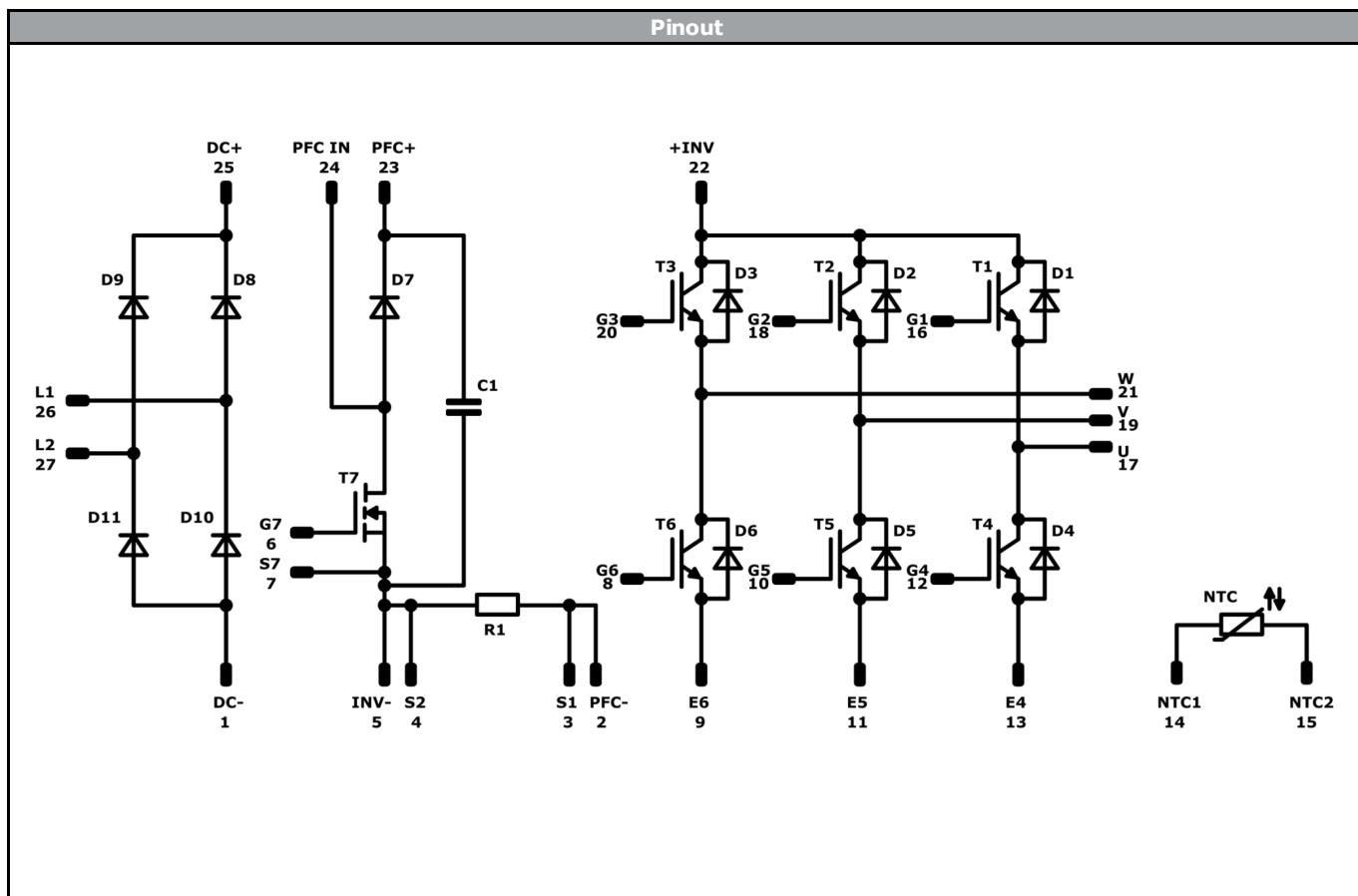
Ordering Code & Marking							
Version				Ordering Code			
without thermal paste 17 mm housing with solder pins				10-F006PPA015SB-M684B			
with thermal paste 17 mm housing with solder pins				10-F006PPA015SB-M684B-/3/			
NN-NNNNNNNNNNNNNN TTTTTTVVWWYY UL VIN LLLL SSSS			Text	Name	Date code	UL & VIN	Lot
				NN-NNNNNNNNNNNNN-TTTTTTW	WWYY	UL VIN	LLLL
			Datamatrix	Type&Ver	Lot number	Serial	Date code
				TTTTTTTW	LLLL	SSSS	WWYY

Outline							
Pin table				Outline			
Pin	X	Y	Function				
1	33,5	0	DC-				
2	30,7	0	PFC-				
3	28	0	S1				
4	25,3	0	S2				
5	22,6	0	INV-				
6	19,9	0	G7				
7	17,2	0	S7				
8	13,5	0	G6				
9	10,8	0	E6				
10	8,1	0	G5				
11	5,4	0	E5				
12	2,7	0	G4				
13	0	0	E4				
14	0	8,6	NTC1				
15	0	11,45	NTC2				
16	0	19,8	G1				
17	0	22,5	U				
18	6	19,8	G2				
19	6	22,5	V				
20	12	19,8	G3				
21	12	22,5	W				
22	17,7	22,5	+INV				
23	20,5	22,5	PFC+				
24	26,5	22,5	PFC IN				
25	33,5	22,5	DC+				
26	33,5	15	L1				
27	33,5	7,5	L2				

Tolerance of pinpositions $\pm 0.5\text{mm}$ at the end of pins
Dimension of coordinate axis is only offset without tolerance



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Identification

ID	Component	Voltage	Current	Function	Comment
D8, D9, D10, D11	Rectifier	1600 V	25 A	Rectifier Diode	
T7	MOSFET	600 V	63 mΩ	PFC Switch	
D7	FWD	600 V	30 A	PFC Diode	
C1	Capacitor	500 V		Capacitor (PFC)	
R1	Shunt		22 A	PFC Shunt	
T1, T2, T3, T4, T5, T6	IGBT	600 V	15 A	Inverter Switch	
D1, D2, D3, D4, D5, D6	FWD	600 V	15 A	Inverter Diode	
NTC	NTC			Thermistor	



10-F006PPA015SB-M684B

datasheet

Vincotech

Packaging instruction			
Standard packaging quantity (SPQ) 135	>SPQ	Standard	<SPQ Sample

Handling instruction			
Handling instructions for flow 0 packages see vincotech.com website.			

Package data			
Package data for flow 0 packages see vincotech.com website.			

UL recognition and file number			
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.			

Document No.:	Date:	Modification:	Pages
10-F006PPA015SB-M684B-D2-14	05 Dec. 2017		

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.